Electronic Acknowledgement Receipt FES ID: 1158265 Application Number: 10811186 Confirmation Number: 2952 Interconnect structure with dielectric barrier and fabrication method Title of Invention: thereof First Named Inventor: Zhen-Cheng Wu Customer Number: 47390 Filer: Daniel R. McClure Filer Authorized By: Attorney Docket Number: 252011-2150 Receipt Date: 17-AUG-2006 Filing Date: 26-MAR-2004 Time Stamp: 07:03:59 Application Type: Utility International Application Number: Payment information:

File Listing:

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Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Amendment - After Non-Final Rejection	00412272.pdf	159544	no	14

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National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/IDO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filling Receipt, in due course.